

UTC UNISONIC TECHNOLOGIES CO., LTD

4N50 **Power MOSFET**

4 A, 500 V N-CHANNEL **POWER MOSFET**

DESCRIPTION

The UTC 4N50 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

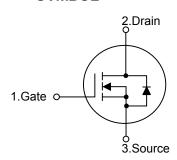
The UTC 4N50 is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

FEATURES

- * I_D= 4A
- * V_{DS}=500V
- * $R_{DS(ON)}$ =2.0 Ω @ V_{GS} =10V
- * High Switching Speed
- * 100% Avalanche Tested

TO-252 TO-251 TO-220 TO-220F

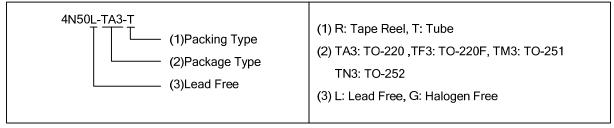
SYMBOL



ORDERING INFORMATION

Ordering Number		Deskons	Pin	Doolsing			
Lead Free	Halogen Free	Package	1	2	3	Packing	
4N50L-TA3-T	4N50G-TA3-T	TO-220	G	D	S	Tube	
4N50L-TF3-T	4N50G-TF3-T	TO-220F	G	D	S	Tube	
4N50L-TM3-T	4N50G-TM3-T	TO-251	G	D	S	Tube	
4N50L-TN3-R	4N50G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	500	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous (T _C =25°C)	I _D	4	Α	
	Pulsed (Note 3)	I _{DM}	16 (Note 2)	Α	
Avalanche Current (Note 3)		I _{AR}	4	Α	
Avalanche Energy	Single Pulsed (Note 4)	E _{AS}	216	mJ	
	Repetitive (Note 3)	E _{AR}	8.5	mJ	
Peak Diode Recovery dv/dt (Note 5)		dv/dt	4.5	V/ns	
Power Dissipation	TO-220		85		
	TO-220F		28	W	
	TO-251/TO-252	Б	52		
Derate above 25°C	TO-220	P_{D}	0.67		
	TO-220F		0.22	W/°C	
	TO-251/TO-252		0.41		
Junction Temperature		T _J	+150	°C	
Storage Temperature		T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Drain current limited by maximum junction temperature
- 3. Repetitive Rating: Pulse width limited by maximum junction temperature
- 4. L = 27mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 5. $I_{SD} \le 4A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220		62.5	°C/W	
	TO-220F	θ_{JA}	62.5		
	TO-251/TO-252		110		
Junction to Case	TO-220		1.47	°C/W	
	TO-220F	θ_{JC}	4.5		
	TO-251/TO-252		2.4		

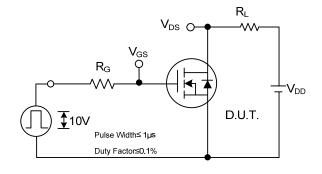
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise noted)

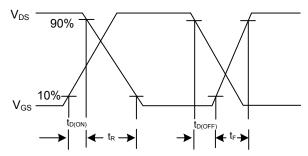
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D =250 μ A, V_{GS} =0 V	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			25	μΑ
Cata Source Lookage Current	rward	- I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA
Gate- Source Leakage Current Re	everse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =2A		1.6	2.2	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}			485	650	pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		65	90	pF
Reverse Transfer Capacitance		C_{RSS}			5	8	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V _{GS} =10V, V _{DS} =400V, I _D =4A -(Note 1, 2)		11	15	nC
Gate to Source Charge		Q_GS			3		nC
Gate to Drain Charge		Q_GD	(Note 1, 2)		5		nC
Turn-ON Delay Time		t _{D(ON)}			14	38	ns
Rise Time		t_R	V_{DD} =250V, I_{D} =4A, R_{G} =25 Ω (Note 1, 2)		21	52	ns
Turn-OFF Delay Time		$t_{D(OFF)}$			27	64	ns
Fall-Time		t_{F}			20	50	ns
SOURCE- DRAIN DIODE RATINGS	S AND (CHARACTERIS	STICS				
Maximum Body-Diode Continuous Current		Is				4	Α
Maximum Body-Diode Pulsed Current		I _{SM}				16	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =4A, V _{GS} =0V			1.6	V
Body Diode Reverse Recovery Time		t _{RR}	I _S =4A, V _{GS} =0V, dI _F /dt=100A/μs		350		ns
Body Diode Reverse Recovery Charge		Q_{RR}	(Note 1)		33		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

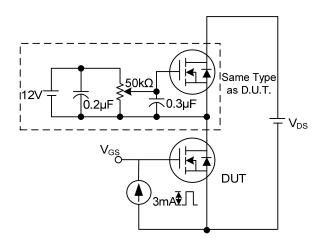
■ TEST CIRCUITS AND WAVEFORMS

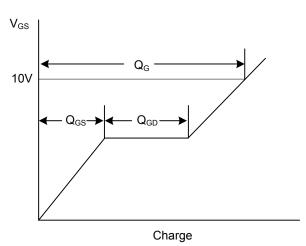




Switching Test Circuit

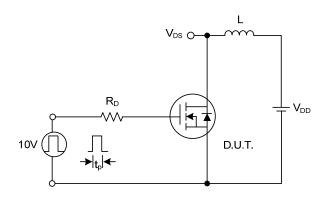
Switching Waveforms

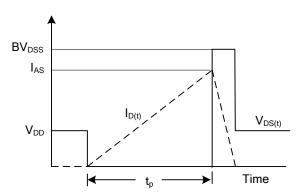




Gate Charge Test Circuit

Gate Charge Waveform

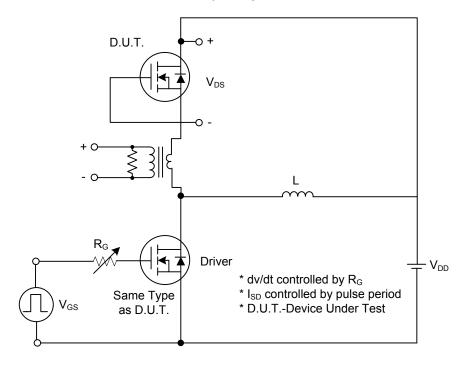




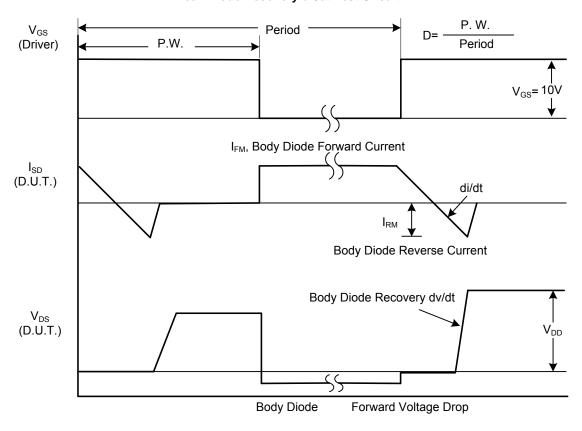
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

■ TEST CIRCUITS AND WAVEFORMS(Cont.)

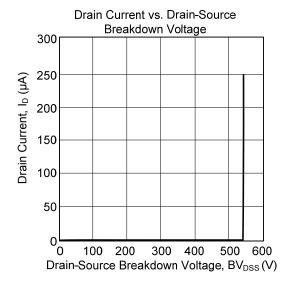


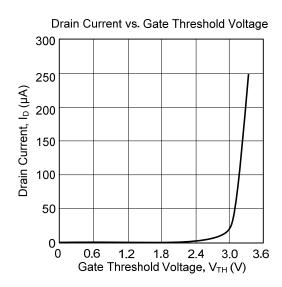
Peak Diode Recovery dv/dt Test Circuit

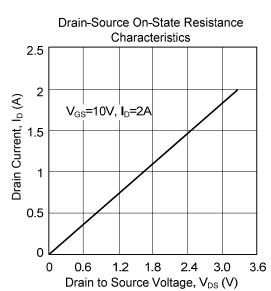


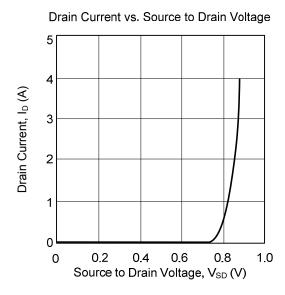
Peak Diode Recovery dv/dt Waveforms

■ TYPICAL CHARACTERISTICS









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